

**PATENT**

*Hej*  
*10-19-00*  
*Chaffin*

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Kinsman et al.

**Serial No.:** 09/538,684

**Filed:** March 30, 2000

**For:** VARIED-THICKNESS HEAT SINK  
FOR INTEGRATED CIRCUIT (IC)  
PACKAGES AND METHOD OF  
FABRICATING IC PACKAGES

**Examiner:** D. Graybill

**Group Art Unit:** 2814

**Attorney Docket No.:** 3056.1US (96-803.1)



**CERTIFICATE OF MAILING**

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail (under 37 C.F.R. § 1.8(a)) on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, Washington, D.C. 20231.

October 10, 2000  
Date of Deposit

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Signature of registered practitioner or other person having reasonable basis to expect mailing to occur on date of deposit shown pursuant to 37 C.F.R. § 1.8(a)(1)(ii)

Deidra Pfeil  
Typed/printed name of person whose signature is contained above

**RESPONSE TO RESTRICTION REQUIREMENT**

Box Non-Fee Amendment  
Commissioner for Patents  
Washington, D.C. 20231

Dear Sir:

Applicants herein acknowledge the restriction requirement in the above-referenced application. Applicants hereby elect, without traverse of the Restriction Requirement, the claims of Group I., claims 1 through 20 and 22 through 45, drawn to a product, classified in Class 257, subclass 666.

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An early Office Action on the merits is respectfully solicited.

Respectfully submitted,



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JRD/sls:djp

Date: October 10, 2000

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